MR27V6402D Preliminary

4,194,304-Word x 16-Bit or 8,388,608-Word x 8-Bit One Time PROM

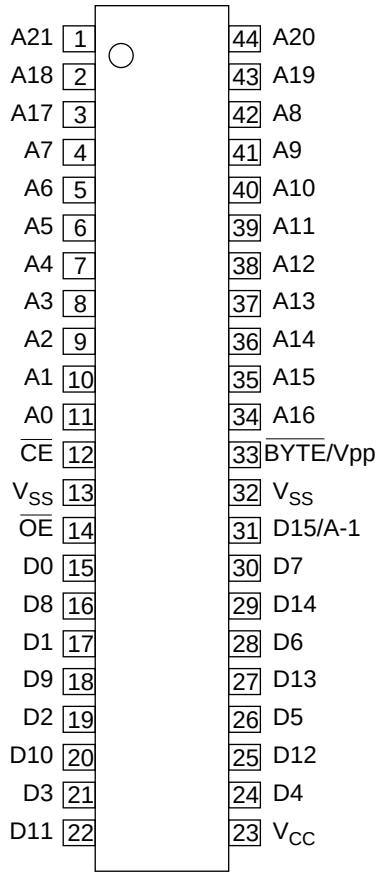
DESCRIPTION

The MR27V6402D is a 64Mbit electrically Programmable Read-Only Memory whose configuration can be electrically switched between 4,194,304 word x 16bit and 8,388,608 word x 8bit. The MR27V6402D operates on a single +3V-3.3V power supply and is TTL compatible. Since the MR27V6402D operates asynchronously , external clocks are not required , making this device easy-to-use. The MR27V6402D is suitable as large-capacity fixed memory for microcomputers and data terminals. It is manufactured using a CMOS double silicon gate technology and is offered in 44-pin SOP package.

FEATURES

- 4,194,304 word x 16bit / 8,388,608 word x 8bit electrically switchable configuration
- Single +3V-3.3V power supply
- Access time 150ns access time (Vcc=+3V)
  120ns access time (Vcc=+3.3V)
- Input / Output TTL compatible
- Three-state output
- Package
  44-pin plastic SOP (SOP44-P-600-1.27-K)

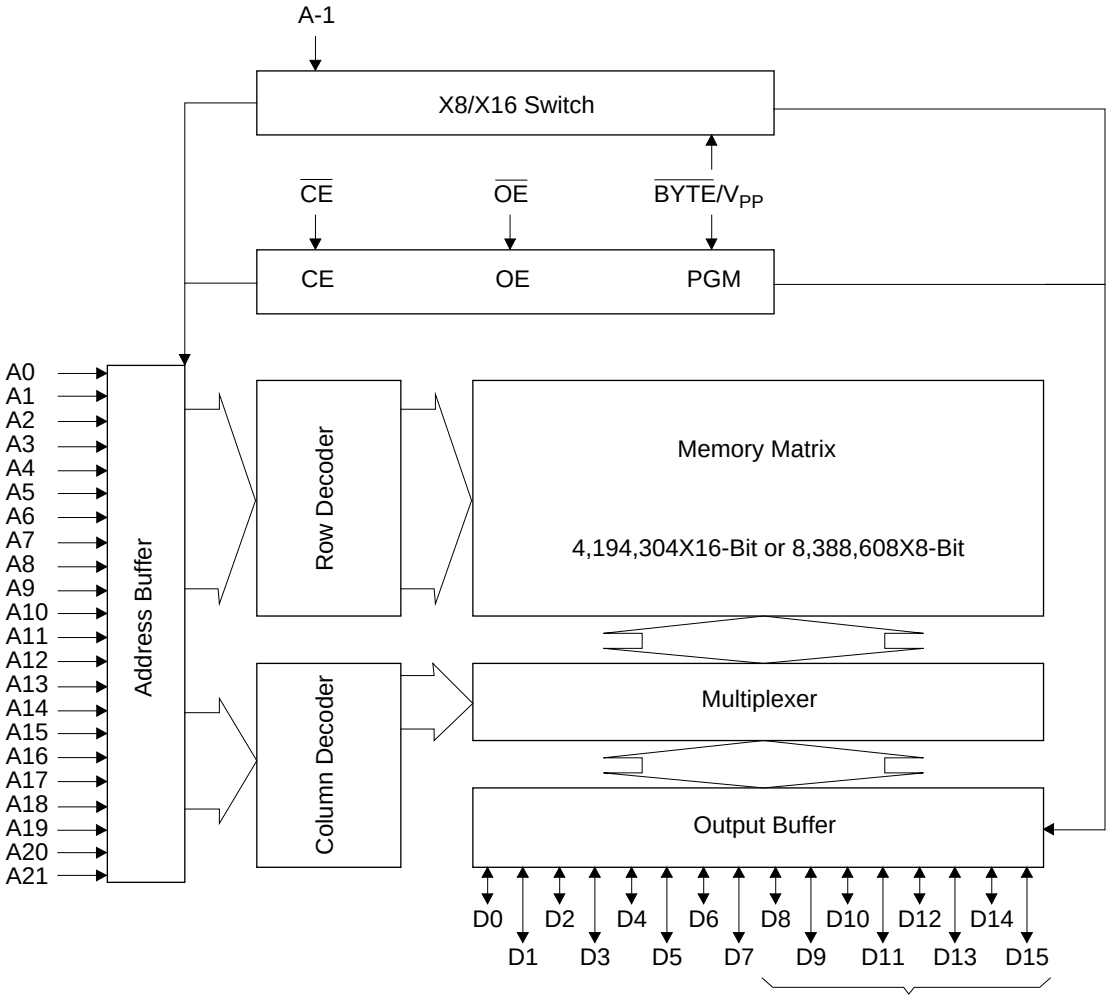
PIN CONFIGURATION (TOP VIEW)



44-pin SOP

PIN NAMES	FUNCTIONS
D15/A-1	Data output / Address input
A0-A21	Address input
D0-D14	Data output
$\overline{CE}$	Chip enable
$\overline{OE}$	Output enable
V_{CC}	Power supply voltage
V_{SS}	GND
$\overline{BYTE}/V_{PP}$	Mode switch / Program power supply voltage

BLOCK DIAGRAM



In 8-bit output mode, these pins are three-stated and pin D15 functions as the A-1 address pin.

FUNCTION TABLE

MODE	$\overline{CE}$	$\overline{OE}$	$\overline{BYTE}/V_{PP}$	V_{CC}	D0 - D7	D8 - D14	D15/A-1
READ (16-Bit)	L	L	H	3.0V to 3.3V	D_{OUT}		
READ (8-Bit)	L	L	L		D_{OUT}	Hi-Z	L/H
OUTPUT DISABLE	L	H	H		Hi-Z		
			L				*
STAND-BY	H	*	H		Hi-Z		
			L				*
PROGRAM	L	H	9.75V	4.0V	D_{IN}		
PROGRAM INHIBIT	H	H			Hi-Z		
PROGRAM VERIFY	H	L			D_{OUT}		

*: Don't Care

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Topr	-	0 to 70	°C
Storage temperature	T_{stg}		-55 to 125	°C
Input voltage	V_I	relative to V_{SS}	-0.5 to V_{CC}+ 0.5	V
Output voltage	V_O		-0.5 to V_{CC} +0.5	V
Power supply voltage	V_{CC}		-0.5 to 5	V
Program power supply voltage	V_{PP}		-0.5 to 11.5	V
Power dissipation per package	P_D	-	1.0	W

RECOMMENDED OPERATING CONDITIONS

(Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
V_{CC} power supply voltage	V_{CC}	V_{CC}=2.7V-3.6V	2.7	-	3.6	V
V_{PP} power supply voltage	V_{PP}		-0.5	-	V_{CC}+0.5	V
Input "H" level	V_{IH}		2.2	-	V_{CC}+0.5	V
Input "L" level	V_{IL}		-0.5	-	0.6	V

Voltage is relative to Vss

ELECTRICAL CHARACTERISTICS (Read operation)

DC Characteristics 1

(V_{CC}=3V±0.3V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I_{LI}	V_I=0 to Vcc	-	-	10	µA
Output leakage current	I_{LO}	V_O=0 to Vcc	-	-	10	µA
V_{CC} power supply current (Standby)	I_{CCSC}	$\overline{CE}$=V_{CC}	-	-	50	µA
	I_{CCST}	$\overline{CE}$=V_{IH}	-	-	1	mA
V_{CC} power supply current (Read)	I_{CCA}	$\overline{CE}$=V_{IL}, $\overline{OE}$=V_{IH} tc=150ns	-	-	45	mA
V_{PP} power supply current	I_{PP}	V_{PP}=V_{CC}	-	-	10	µA
Input "H" level	V_{IH}	-	2.2	-	V_{CC}+0.5	V
Input "L" level	V_{IL}	-	-0.5	-	0.6	V
Output "H" level	V_{OH2}	I_{OH}=-200uA	V_{CC}-0.4	-	-	V
Output "L" level	V_{OL2}	I_{OL}=1mA	-	-	0.4	V

Voltage is relative to Vss

DC Characteristics 2

(V_{CC}=3.3V±0.3V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I_{LI}	V_I=0 to Vcc	-	-	10	µA
Output leakage current	I_{LO}	V_O=0 to Vcc	-	-	10	µA
V_{CC} power supply current (Standby)	I_{CCSC}	$\overline{CE}$=V_{CC}	-	-	50	µA
	I_{CCST}	$\overline{CE}$=V_{IH}	-	-	1	mA
V_{CC} power supply current (Read)	I_{CCA}	$\overline{CE}$=V_{IL}, $\overline{OE}$=V_{IH} tc=120ns	-	-	50	mA
V_{PP} power supply current	I_{PP}	V_{PP}=V_{CC}	-	-	10	µA
Input "H" level	V_{IH}	-	2.2	-	V_{CC}+0.5	V
Input "L" level	V_{IL}	-	-0.5	-	0.6	V
Output "H" level	V_{OH2}	I_{OH}=-200µA	V_{CC}-0.4	-	-	V
Output "L" level	V_{OL2}	I_{OL}=1mA	-	-	0.4	V

Voltage is relative to Vss

AC Characteristics 1

(V_{CC}=3V±0.3V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	T_C	-	150	-	ns
Address access time	T_{ACC}	$\overline{CE}$=$\overline{OE}$=V_{IL}	-	150	ns
$\overline{CE}$ access time	T_{CE}	$\overline{OE}$=V_{IL}	-	150	ns
$\overline{OE}$ access time	T_{OE}	$\overline{CE}$=V_{IL}	-	60	ns
Output disable time	T_{CHZ}	$\overline{OE}$=V_{IL}	0	50	ns
	T_{OHZ}	$\overline{CE}$=V_{IL}	0	45	ns
Output hold time	T_{OH}	$\overline{CE}$=$\overline{OE}$=V_{IL}	0	-	ns

Measurement conditions

Input signal level ---------- 0V/3V
Input timing reference level ---------- 0.8V/2.0V
Output load ---------- 100pF
Output timing reference level ---------- 0.8V/2.0V

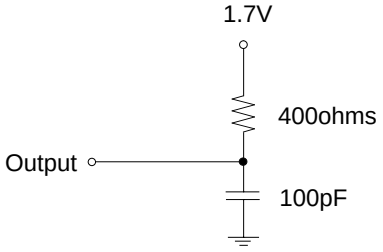
AC Characteristics 2

(V_{CC}=3.3V±0.3V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	T_C	-	120	-	ns
Address access time	T_{ACC}	$\overline{CE}$=$\overline{OE}$=V_{IL}	-	120	ns
$\overline{CE}$ access time	T_{CE}	$\overline{OE}$=V_{IL}	-	120	ns
$\overline{OE}$ access time	T_{OE}	$\overline{CE}$=V_{IL}	-	50	ns
Output disable time	T_{CHZ}	$\overline{OE}$=V_{IL}	0	40	ns
	T_{OHZ}	$\overline{CE}$=V_{IL}	0	35	ns
Output hold time	T_{OH}	$\overline{CE}$=$\overline{OE}$=V_{IL}	0	-	ns

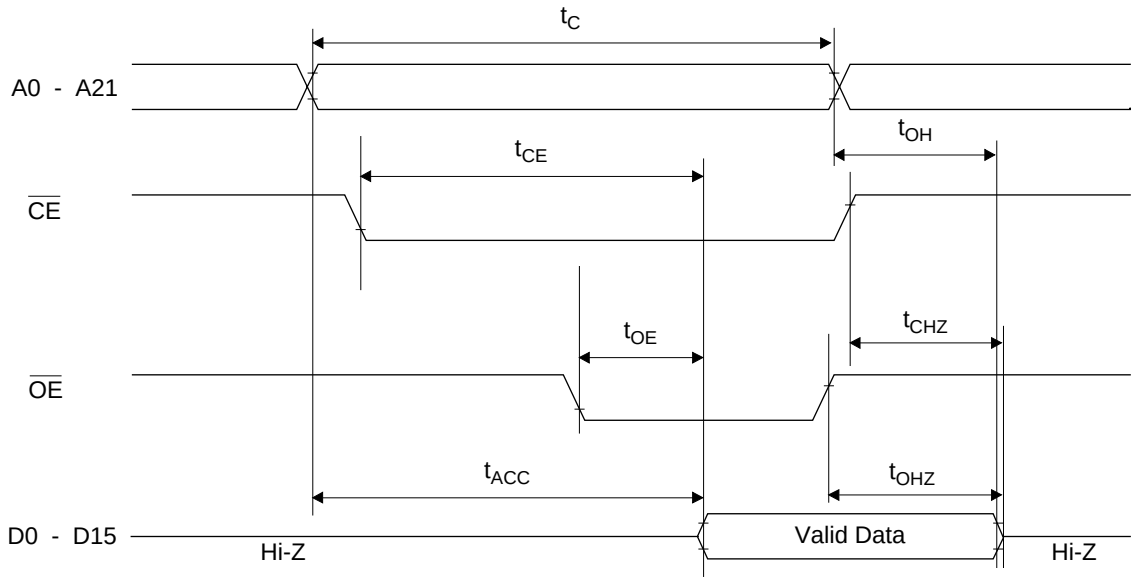
Measurement conditions

Input signal level ---------- 0V/3V
Input timing reference level ---------- 0.8V/2.0V
Output load ---------- 100pF
Output timing reference level ---------- 0.8V/2.0V

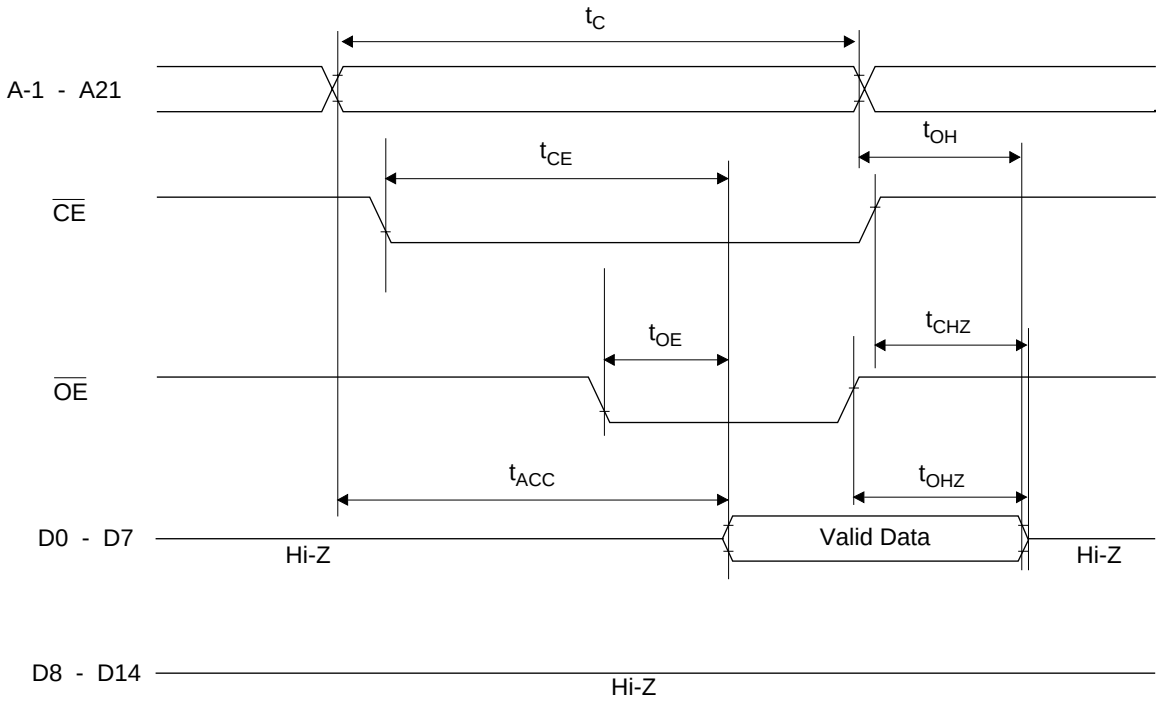


TIMING CHART (READ CYCLE)

16-Bit Read Mode ($\overline{BYTE}$=V_{IH})



8-Bit Read Mode ($\overline{BYTE}$=V_{IL})



ELECTRICAL CHARACTERISTICS (Programming operation)

DC Characteristics

(Ta=25°C±5°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I_{LI}	$V_I=V_{CC}+0.5V$	-	-	10	µA
V_{PP} power supply current (Program)	I_{PP2}	$\overline{CE}=V_{IL}$	-	-	50	mA
V_{CC} power supply current	I_{CC}	-	-	-	50	mA
Input "H" level	V_{IH}	-	3.0	-	$V_{CC}+0.5$	V
Input "L" level	V_{IL}	-	-0.5	-	0.8	V
Output "H" level	V_{OH}	$I_{OH}=-400µA$	2.4	-	-	V
Output "L" level	V_{OL}	$I_{OL}=2.1mA$	-	-	0.45	V
Program voltage	V_{PP}	-	9.5	9.75	10.0	V
V_{CC} power supply voltage	V_{CC}	-	3.9	4.0	4.1	V

Voltage is relative to Vss

AC Characteristics

(V_{cc}=4.0V±0.1V,V_{pp}=9.75V±0.25V,Ta=25°C±5°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Address set-up time	T_{AS}	-	100	-	-	ns
$\overline{OE}$ set-up time	T_{OES}	-	2	-	-	µs
Data set-up time	T_{DS}	-	100	-	-	ns
Address hold time	T_{AH}	-	2	-	-	µs
Data hold time	T_{DH}	-	100	-	-	ns
Output float delay from $\overline{OE}$	T_{OHZ}	-	0	-	100	ns
V_{PP} voltage set-up time	T_{VS}	-	2	-	-	µs
Program pulse width	T_{PW}	-	9	10	11	µs
Data valid from $\overline{OE}$	T_{OE}	-	-	-	100	ns
Address hold from $\overline{OE}$ high	T_{AHO}	-	0	-	-	ns

Pin Check Function

Pin Check Function is to check contact between each device-pin and each socket-lead with EPROM programmer.

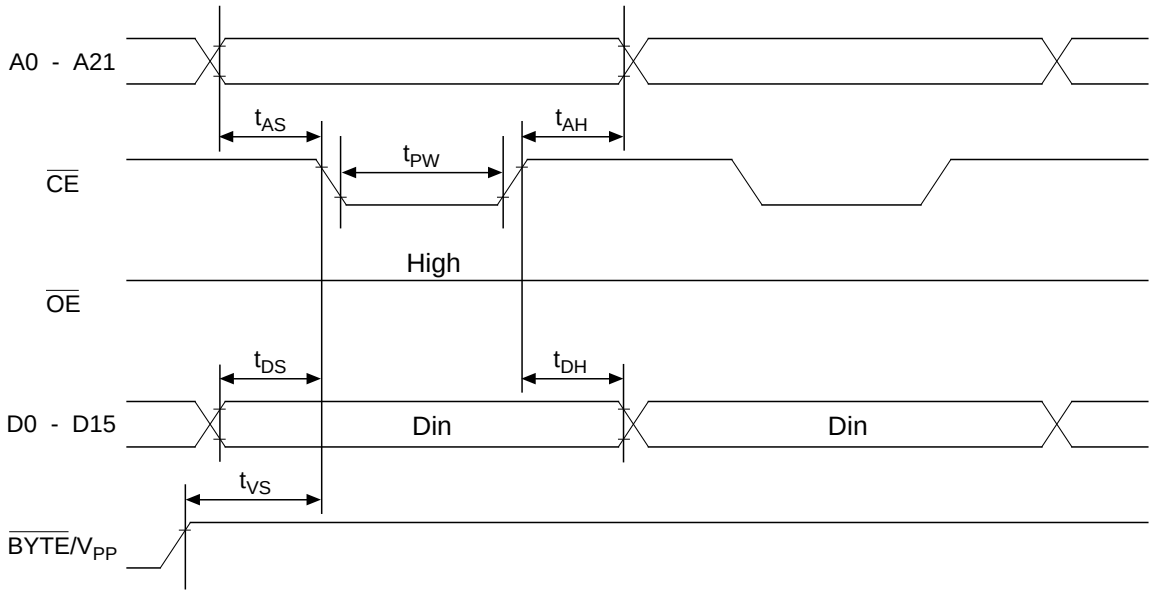
Setting up address as the following condition call the preprogrammed codes on device outputs.

(V_{cc}=3.3V±0.3V,$\overline{CE}$=$\overline{OE}$=V_{IL},$\overline{BYTE}$/V_{pp}=V_{IH},Ta=25°C±5°C)

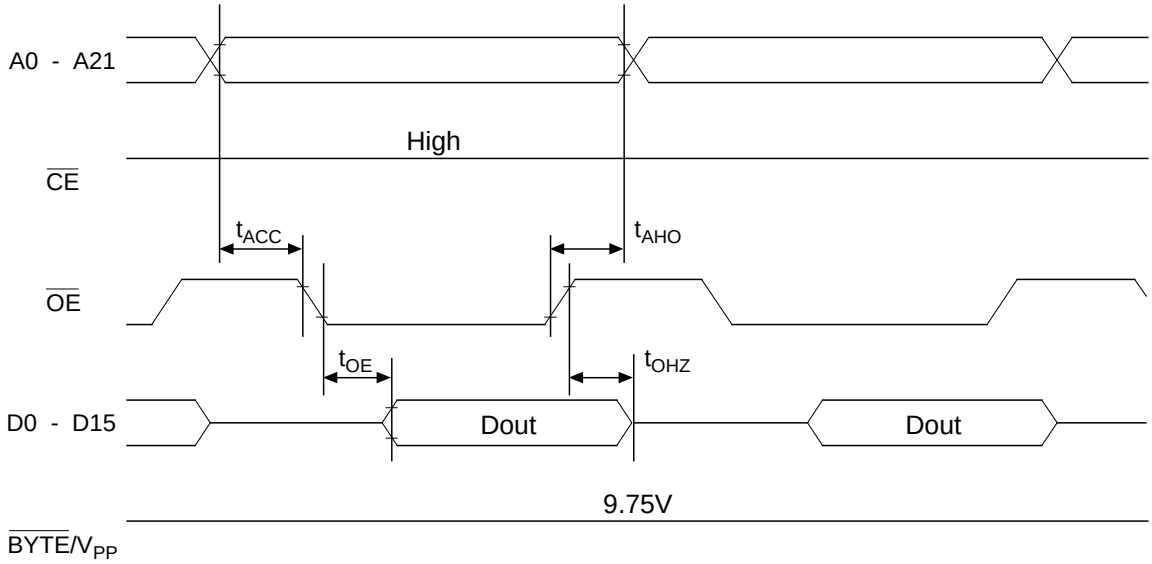
A0	A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12	A13	A14	A15	A16	A17	A18	A19	A20	A21	DATA
0	1	0	1	0	1	0	1	0	VH*	0	1	0	1	0	1	0	0	1	1	0	0	FF00
1	0	1	0	1	0	1	0	1	VH*	1	0	1	0	1	0	1	1	0	0	1	1	00FF
Other conditions																						FFFF

* :VH=8V±0.25V

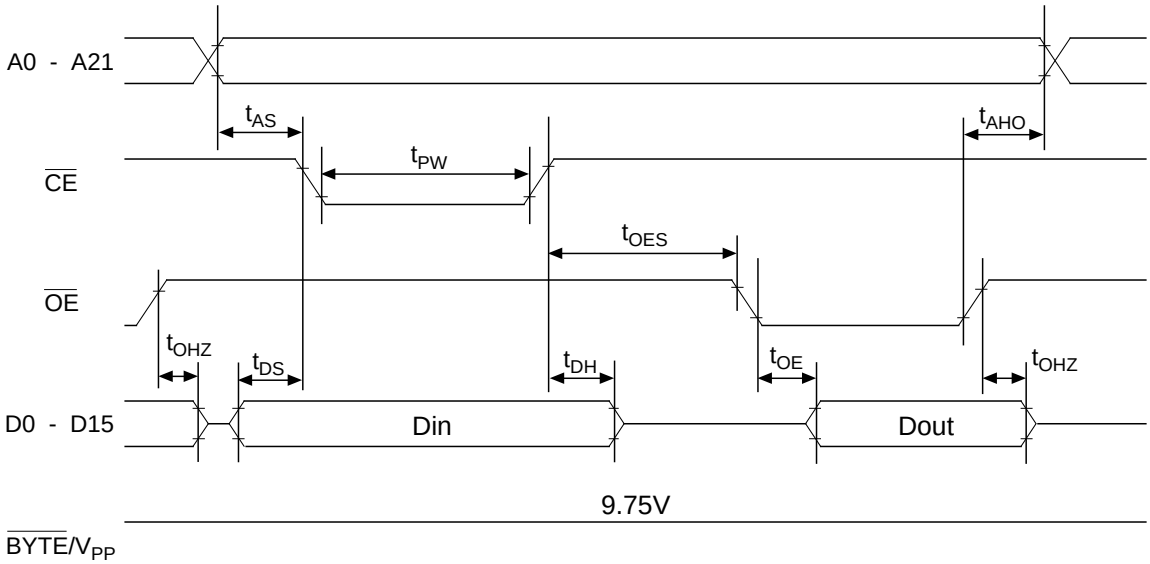
Consecutive Programming Waveforms



Consecutive Program Verify Waveforms



Program and Program Verify Cycle Waveforms

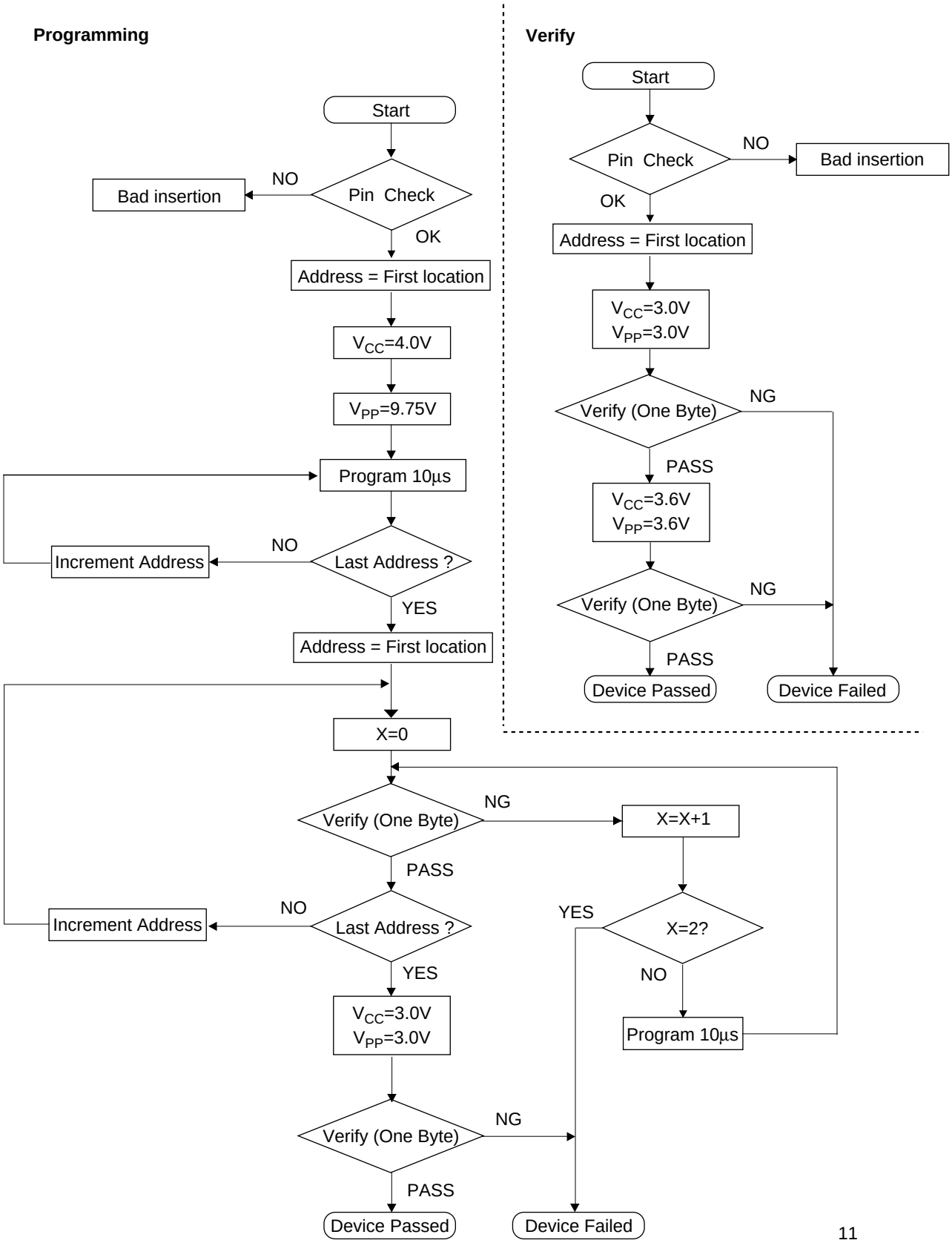


PIN Capacitance

(V_{CC}=3.3V, Ta=25°C, f=1MHz)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	C_{IN1}	V_I=0V	-	-	12	pF
$\overline{BYTE}/V_{PP}$	C_{IN2}		-	-	120	
Output	C_{OUT}	V_O=0V	-	-	15	

Programming / Verify Flow Chart



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ADDRESSES & SEMICONDUCTOR WEB SITES

OKI Electric Industry Co., Ltd.,
Device Business Group,
10-3, Shibaura, 4-chome,
Minato-ku, Tokyo 108, Japan,
Tel.: +81-(0)3-5445-6327,
Fax.: +81-(0)3-5445-6328,
http://www.oki.co.jp/semi/

OKI Semiconductor Group,
785 North Mary Avenue,
Sunnyvale, CA 94086, U.S.A.,
Tel.: +1-408-720-1900,
Fax.: +1-408-720-1918,
http://www.okisemi.com/

OKI Electric Europe GmbH,
Head Office Europe,
Hellersbergstrasse 2,
D-41460 Neuss, Germany,
Tel: +49-2131-15960,
Fax: +49-2131-103539,
http://www.oki-europe.de/

OKI Electronics (Hong Kong) Ltd.,
Suite 1901-1&19, Tower 3,
China Hong Kong City,
33 Canton Road, Tsimshatsui,
Kowloon, Hong Kong,
Tel.: +852-2-736-2336,
Fax.: +852-2-736-2395

OKI Semiconductor (Asia) Pte. Ltd.,
78 Shenton Way 09-01,
Singapore 0207,
Tel.: +65-221-3722,
Fax.: +65-323-5376

OKI Semiconductor (Asia) Pte. Ltd.,
Taipei Branch,
7th Fl. No.260, Tun Hwa North Road,
Taipei, Taiwan, R.O.C.,
Sumitomo-Flysun Building,
Tel.: +886-2-2719-2561,
Fax.: +886-2-2715-2892
http://www.oki.net.tw/

For further information, please contact: